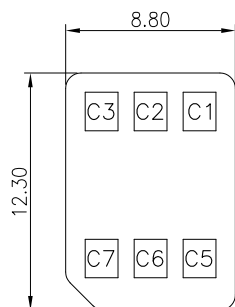
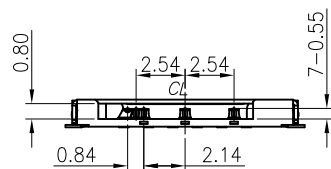
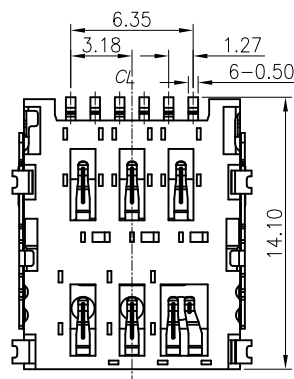
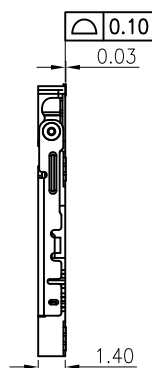
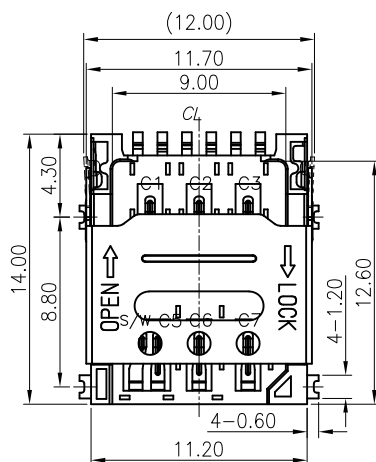
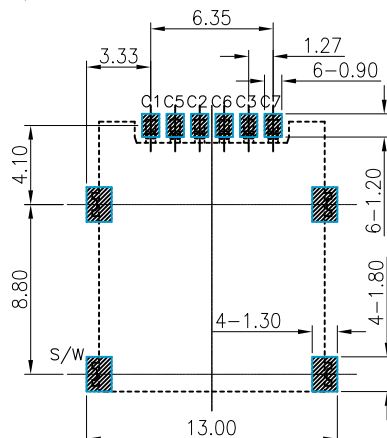


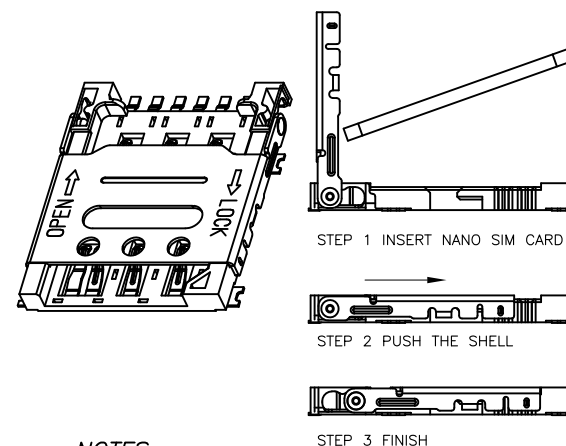
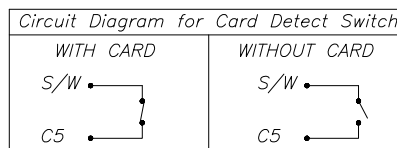
更改 REV	数量 MODIFICATION
A	EC09005
B	EC12619



PIN NO.	PIN NAME
C1	VCC
C2	RST
C3	CLK
C5	GND
C6	VPP
C7	I/O
S/W	Switch Pin



RECOMMENDED PCB LAYOUT
TOLERANCE ± 0.05
SMT SOLDER AREA



NOTES:

1. MATERIAL:

- 1.1 Housing: High Temperature Thermoplastic UL94V-0; Color Black.
- 1.2 Terminal: Copper Alloy, $T=0.12\text{mm}$.
- 1.3 Shell: Stainless Steel, $T=0.20\text{mm}$.

2. FINISH:

- 2.1 Terminal: Plated Gold on the Contact Area and Solder Tails
- 2.2 Peg: Plated Gold on the Solder Tails.

3. SPECIALITY:

- 3.1 Rated current: 0.5A
- 3.2 Rated voltage: 50V
- 3.3 Contact Resistance: $80\text{m}\Omega$ MAX
- 3.4 Insulation Resistance: $100\text{M}\Omega$ MIN 100V DC
- 3.5 Dielectric withstanding voltage: 100V AC.
- 3.6 Solder ability: $245\pm 5^\circ\text{C}$, $5\pm 0.5\text{s}$.
- 3.7 Operating condition: Temperature: $-40^\circ\text{C}\sim +105^\circ\text{C}$
Humidity: 80% R.H MAX



GENERAL TOLERANCE		KINGCONN 皇海科技股份有限公司	
X ± 0.50	X $\pm 5^\circ$	名 称(TITLE) NANO SIM 掀盖 1.4H	
.X ± 0.30	.X $\pm 2^\circ$		
.XX ± 0.20	.XX $\pm 1^\circ$		
单 位(UNIT) mm	料 号(PART NO.) 7SIMC-F0-0023	图 号(DWG NO.) 7SIMC-F0-0023	张 数 1 / 1
审 核(APPROVAL)	核 对(CHECKED)	制 图(DRAWN)	比 例 SCALE 1:1
			更 改 REV B